



## **40V P-Channel Enhancement Mode MOSFET**

Voltage

-40 V

Current

-67 A

#### **Features**

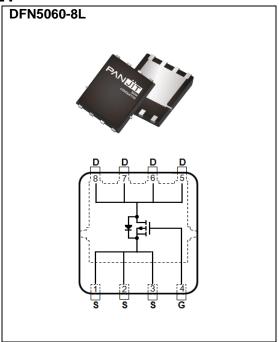
- $R_{DS(ON)}$ ,  $V_{GS}@-10V$ ,  $I_D@-20A<9.4m\Omega$
- RDS(ON), VGS@-4.5V, ID@-10A<14.3m $\Omega$
- 100% UIS tested
- Reliable and Rugged
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: DFN5060-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.08 grams



## **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	-40	- V	
Gate-Source Voltage		$V_{GS}$	±25	V	
Continuous Drain Current(Note 3)	T <sub>C</sub> =25°C	l <sub>D</sub>	-67		
	Tc=100°C		-47	Α	
Pulsed Drain Current(Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	-228		
Power Dissipation	T <sub>C</sub> =25°C	-	75	W	
	T <sub>C</sub> =100°C	Po	38		
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C	I <sub>D</sub>	-14	А	
	T <sub>A</sub> =70°C		-11.7		
Power Dissipation	T <sub>A</sub> =25°C	D-	3.3	W	
	T <sub>A</sub> =70°C	Po	2.3		
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	132	mJ	
Operating Junction and Storage Temperature Range		$T_{J}$ , $T_{STG}$	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	R <sub>0JC</sub>	2	°C/W	
	Junction to Ambient	$R_{\theta JA}$	45		





### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static			•				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	BV <sub>DSS</sub> V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA -40		-	-		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1	-1.9	-2.5	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	-	7.5	9.4	mΩ	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A	-	11	14.3		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V	-	-	-1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V	-	-	±100	nA	
Dynamic <sup>(Note 6)</sup>	•			•		•	
Total Gate Charge	$Q_g$	.,	-	59	-	nC	
Gate-Source Charge	Qgs	V <sub>DS</sub> =-32V, I <sub>D</sub> =-20A,	-	9	-		
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =-10V	-	20	-		
Input Capacitance	Ciss	.,	-	3300	-	pF	
Output Capacitance	Coss	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V,	-	380	-		
Reverse Transfer Capacitance	Crss	f=1MHz	-	240	-		
Gate resistance	Rg	f=1MHz	-	4	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>	.,	-	13	-	ns	
Turn-On Rise Time	tr	V <sub>DS</sub> =-32, I <sub>D</sub> =-20A,	-	16	-		
Turn-Off Delay Time	td <sub>(off)</sub>	V <sub>GS</sub> =-10V, R <sub>G</sub> =3Ω	-	54	-		
Turn-Off Fall Time	tf	(Note 2)	-	33	-		
Drain-Source Diode	-		-11		•		
Diode Forward Current	Is	T 05 <sup>0</sup> 0	-	-	-67	A	
Pulsed Diode Forward Current	I <sub>SM</sub>	T <sub>C</sub> =25°C	-	-	-228		
Diode Forward Voltage	$V_{SD}$	Is=-20A, V <sub>G</sub> s=0V	-	-0.85	-1.3	V	
Reverse Recovery Time	Trr	V <sub>GS</sub> =0V, I <sub>S</sub> =-20A	-	23	-	ns	
Reverse Recovery Charge	Qrr	dls/dt=100A/us	-	11	-	nC	

#### NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH,  $I_{AS}$ =-23A,  $V_{DD}$ =-30V,  $V_{GS}$ =-10V, Starting  $T_{J}$ =25°C.
- 6. Guaranteed by design, not subject to production testing.





#### **TYPICAL CHARACTERISTIC CURVES**

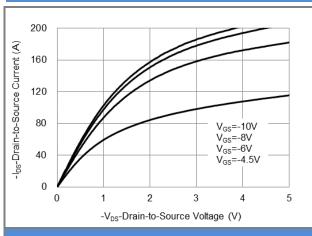


Fig.1 On-Region Characteristics

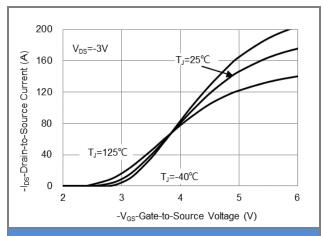


Fig.2 Transfer Characteristics

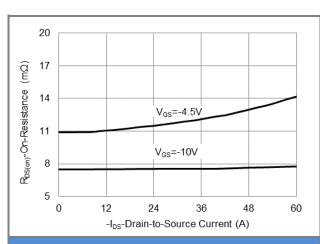


Fig.3 On-Resistance vs. Drain Current

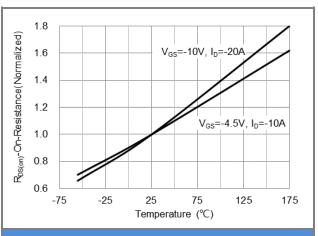
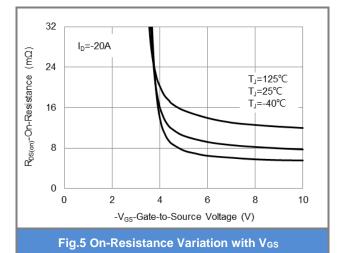
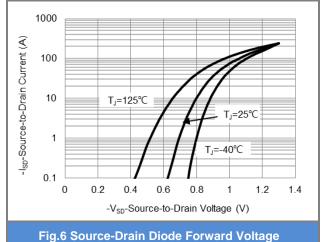


Fig.4 On-Resistance vs. Junction temperature









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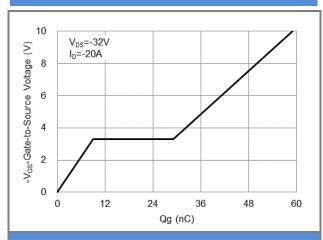


Fig.7 Gate-Charge Characteristics

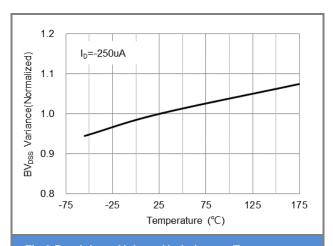


Fig.8 Breakdown Voltage Variation vs. Temperature

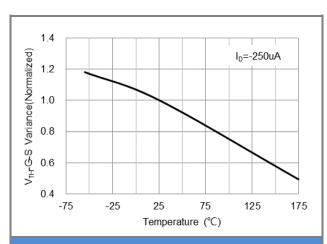


Fig.9 Threshold Voltage Variation with Temperature

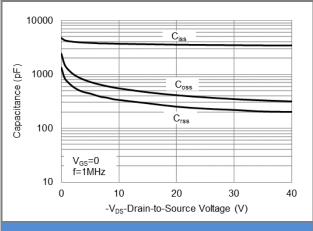


Fig.10 Capacitance vs. Drain-Source Voltage

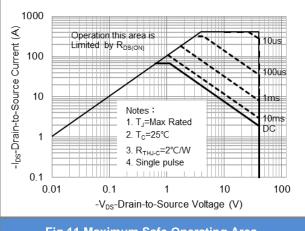


Fig.11 Maximum Safe Operating Area

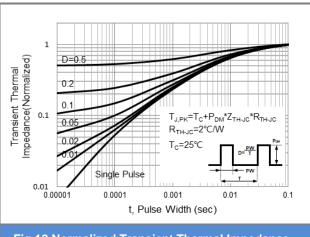


Fig.12 Normalized Transient Thermal Impedance

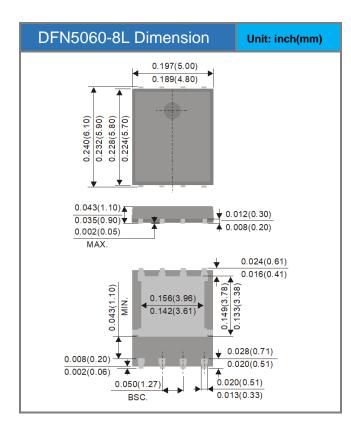


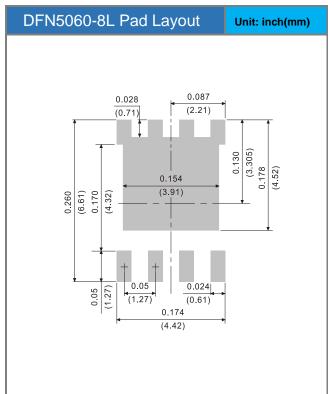


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJQ5451E-AU	DFN5060-8L	3K pcs / 13" reel	Q5451E	

## **Packaging Information & Mounting Pad Layout**









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